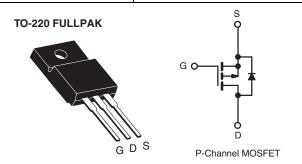


Vishay Siliconix

### **Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	- 200			
$R_{DS(on)}\left(\Omega\right)$	V <sub>GS</sub> = - 10 V 0.50			
Q <sub>g</sub> (Max.) (nC)	44			
Q <sub>gs</sub> (nC)	7.1			
Q <sub>gd</sub> (nC)	27			
Configuration	Single			



#### **FEATURES**

- · Isolated Package
- High Voltage Isolation = 2.5 kV<sub>RMS</sub> (t = 60 s; f = 60 Hz)



RoHS\*

- Sink to Lead Creepage Distance = 4.8 mm
- P-Channel
- · Dynamic dV/dt Rating
- Low Thermal Resistance
- Lead (Pb)-free Available

#### **DESCRIPTION**

Third generation Power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION			
Package	TO-220 FULLPAK		
Load (Dh) free	IRFI9640GPbF		
Lead (Pb)-free	SiHFI9640G-E3		
SnPb	IRFI9640G		
SILL	SiHFI9640G		

PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	- 200	V	
Gate-Source Voltage			$V_{GS}$	± 20	] v	
Continuous Drain Current	V <sub>GS</sub> at - 10 V	T <sub>C</sub> = 25 °C	I.	- 6.1	А	
	VGS at - 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	- 3.9		
Pulsed Drain Current <sup>a</sup>			I <sub>DM</sub>	- 24	•	
Linear Derating Factor				0.32	W/°C	
Single Pulse Avalanche Energy <sup>b</sup>			E <sub>AS</sub>	650	mJ	
Repetitive Avalanche Currenta			I <sub>AR</sub>	- 6.1	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	4.0	mJ	
Maximum Power Dissipation	T <sub>C</sub> = 25 °C		P <sub>D</sub>	40	W	
Peak Diode Recovery dV/dtc			dV/dt	- 5.0	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	- 55 to + 150	°C	
Soldering Recommendations (Peak Temperature)	for 1	0 s		300 <sup>d</sup>		
Mounting Torque	6 20 or M	6-32 or M3 screw		10	lbf ⋅ in	
	6-32 OF IVIS SCIEW			1.1	N⋅m	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 26 mH,  $R_G$  = 25  $\Omega$ ,  $I_{AS}$  = 6.1 A (see fig. 12).
- c.  $I_{SD} \le$  11 A,  $dI/dt \le$  150 A/µs,  $V_{DD} \le V_{DS}$ ,  $T_J \le$  150 °C.
- d. 1.6 mm from case.

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply

# IRFI9640G, SiHFI9640G

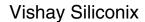
# Vishay Siliconix



THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	65	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	3.1	C/VV	

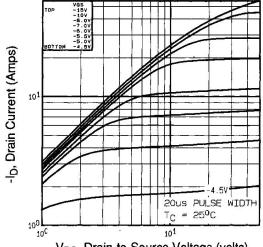
PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		•					
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	- 200	-	-	V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	-	- 0.22	-	V/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	- 2.0	-	- 4.0	V	
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V			± 100	nA
Zana Cata Valtana Darin O		V <sub>DS</sub> =	V <sub>DS</sub> = - 200 V, V <sub>GS</sub> = 0 V		-	- 100	,
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 160	V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	- 500	μΑ
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V	I <sub>D</sub> = - 3.7 A <sup>b</sup>	-	-	0.50	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	- 50 V, I <sub>D</sub> = - 3.7 A <sup>b</sup>	3.4	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V,		-	1200	-	- pF
Output Capacitance	C <sub>oss</sub>		$V_{DS} = -25 \text{ V},$		370	-	
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	80	-	
Drain to Sink Capacitance	С		f = 1.0 MHz	-	12	-	
Total Gate Charge	Qg			-	-	44	
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = - 10 V	$I_D = -11 \text{ A}, V_{DS} = -160 \text{ V},$ see fig. 6 and $13^b$	-	-	7.1	nC
Gate-Drain Charge	Q <sub>gd</sub>	1		-	-	27	
Turn-On Delay Time	t <sub>d(on)</sub>			-	14	-	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 100 V, $I_{D}$ = - 11 A, $R_{G}$ = 9.1 $\Omega$ , $R_{D}$ = 8.6 $\Omega$ , see fig. 10 <sup>b</sup>		-	43	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	39	-	
Fall Time	t <sub>f</sub>			-	38	-	
Internal Drain Inductance	$L_{D}$	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	
Internal Source Inductance	L <sub>S</sub>			-	7.5	-	- nH
Drain-Source Body Diode Characteristic	s	•		I.	I.	l	
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	- 6.1	
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>			i	-	- 24	A
Body Diode Voltage	$V_{SD}$	T <sub>J</sub> = 25 °C,	T <sub>J</sub> = 25 °C, I <sub>S</sub> = - 6.1 A, V <sub>GS</sub> = 0 V <sup>b</sup>		-	- 5 .0	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = -11 A, dl/dt = 100 A/μs <sup>b</sup>		-	250	300	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			-	2.9	3.6	μС
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				_D)	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq$  300  $\mu s;$  duty cycle  $\leq$  2 %.





#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



-V<sub>DS</sub>, Drain-to-Source Voltage (volts)
Fig. 1 - Typical Output Characteristics, T<sub>C</sub>= 25 °C

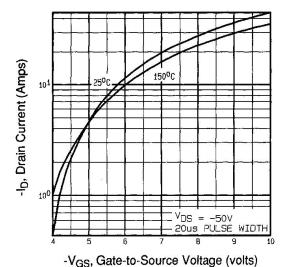


Fig. 3 - Typical Transfer Characteristics

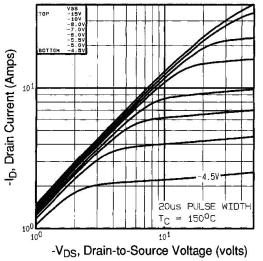


Fig. 2 - Typical Output Characteristics, T<sub>C</sub>= 150 °C

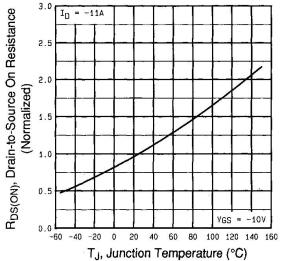


Fig. 4 - Normalized On-Resistance vs. Temperature

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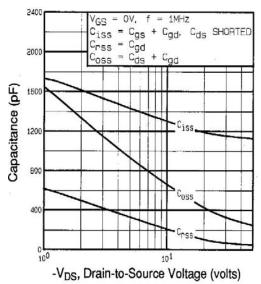


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

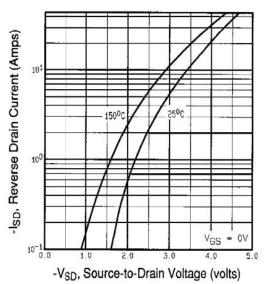


Fig. 7 - Typical Source-Drain Diode Forward Voltage

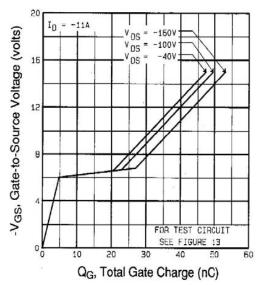


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

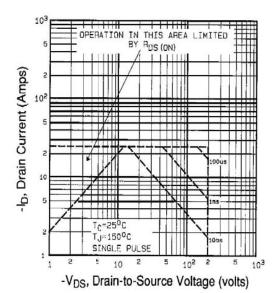
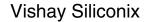


Fig. 8 - Maximum Safe Operating Area





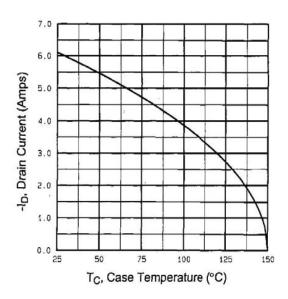


Fig. 9 - Maximum Drain Current vs. Case Temperature

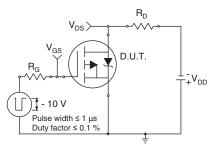


Fig. 10a - Switching Time Test Circuit

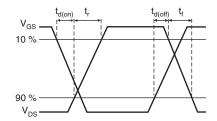


Fig. 10b - Switching Time Waveforms

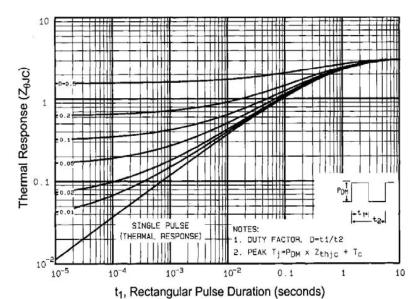


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

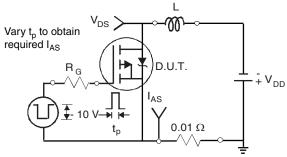


Fig. 12a - Unclamped Inductive Test Circuit

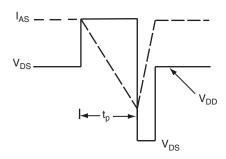
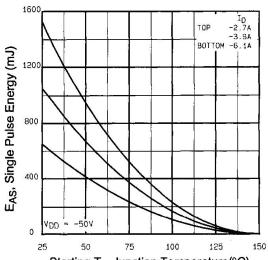


Fig. 12b - Unclamped Inductive Waveforms

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Starting T<sub>J</sub>, Junction Temperature(°C) Fig. 12c - Maximum Avalanche Energy vs. Drain Current

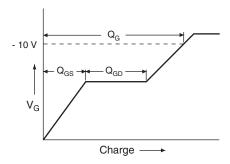


Fig. 13a - Basic Gate Charge Waveform

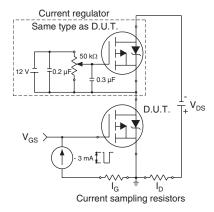
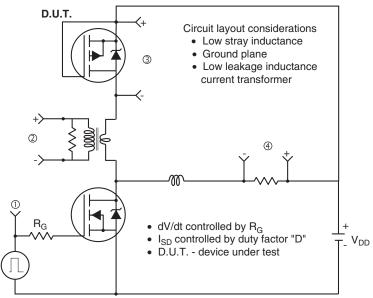


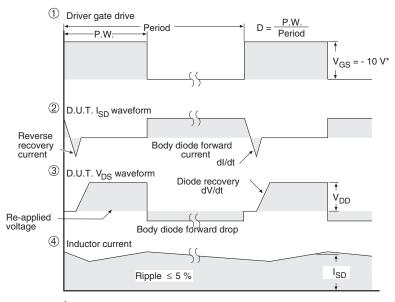
Fig. 13b - Gate Charge Test Circuit



### Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver



V<sub>GS</sub> = -5 V for logic level and -3 V drive devices

Fig. 14 - For P-Channel

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